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Vishay Siliconix

RoHS

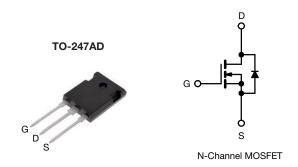
COMPLIANT

HALOGEN

**FREE** 

# **E Series Power MOSFET with Fast Body Diode**

PRODUCT SUMMARY					
V <sub>DS</sub> (V) at T <sub>J</sub> max.	700				
R <sub>DS(on)</sub> typ. at 25 °C (Ω)	$V_{GS} = 10 \text{ V}$	0.041			
Q <sub>g</sub> max. (nC)	371				
Q <sub>gs</sub> (nC)	65				
Q <sub>gd</sub> (nC)	93				
Configuration	Single				



#### **FEATURES**

- Fast body diode MOSFET using E series technology
- Reduced t<sub>rr</sub>, Q<sub>rr</sub>, and I<sub>RRM</sub>
- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (Ciss)
- · Low switching losses due to reduced Q<sub>rr</sub>
- Ultra low gate charge (Qa)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

#### **APPLICATIONS**

- Telecommunications
  - Server and telecom power supplies
- Lighting
- High-intensity lighting (HID)
- Light emitting diodes (LEDs)
- Consumer and computing
  - ATX power supplies
- Industrial
  - Welding
- Battery chargers
- Renewable energy
  - Solar (PV inverters)
- Switching mode power supplies (SMPS)
- · Applications using the following topologies
  - LLC
  - Phase shifted bridge (ZVS)
  - 3-level inverter
  - AC/DC bridge

ORDERING INFORMATION	
Package	TO-247AD
Lead (Pb)-Free and Halogen-Free	SiHW61N65EF-GE3

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>C</sub> = 25 °C, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V <sub>DS</sub>	650	V	
Gate-Source Voltage			$V_{GS}$	± 30	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	
Continuous Drain Current (T <sub>J</sub> = 150 °C)	V at 10 V	T <sub>C</sub> = 25 °C T <sub>C</sub> = 100 °C	- I <sub>D</sub>	64	A	
	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C		41		
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	199		
Linear Derating Factor				4.2	W/°C	
Single Pulse Avalanche Energy b			E <sub>AS</sub>	1142	mJ	
Maximum Power Dissipation			$P_{D}$	520	W	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Drain-Source Voltage Slope	$T_{J} = T_{J}$	T <sub>J</sub> = 125 °C		70	\//no	
Reverse Diode dV/dt <sup>d</sup>			dV/dt	50	- V/ns	
Soldering Recommendations (Peak temperature) c For 10 s			300	°C		

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b.  $V_{DD} = 140 \text{ V}$ , starting  $T_J = 25 \,^{\circ}\text{C}$ ,  $L = 28.2 \,\text{mH}$ ,  $R_g = 25 \,\Omega$ ,  $I_{AS} = 9 \,\text{A}$ .
- c. 1.6 mm from case.
- d.  $I_{SD} \le I_D$ , dI/dt = 500 A/ $\mu$ s, starting  $T_J = 25$  °C.



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THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	TYP.	MAX.	UNIT		
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	40	°C/W		
Maximum Junction-to-Case (Drain)	$R_{thJC}$	-	0.24			

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 250 μA	650	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	Reference to 25 °C, I <sub>D</sub> = 10 mA		0.81	-	V/°C
Gate-Source Threshold Voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	- V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2.0	_	4.0	V
Onto Common Londono		V <sub>GS</sub> = ± 20 V		-	_	± 100	nA
Gate-Source Leakage	I <sub>GSS</sub>	,	$V_{GS} = \pm 30 \text{ V}$	-	-	± 1	μΑ
Zava Cata Valtaga Drain Current		V <sub>DS</sub> =	= 520 V, V <sub>GS</sub> = 0 V	-	-	1	μΑ
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 520 V	', V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	500	
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	$I_D = 30.5 A$	-	0.041	0.047	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> =	= 30 V, I <sub>D</sub> = 30.5 A	-	23	-	S
Dynamic							
Input Capacitance	C <sub>iss</sub>		$V_{GS} = 0 V$ ,	=.	7407	-	
Output Capacitance	Coss	,	$V_{DS} = 100 \text{ V},$	-	351	-	
Reverse Transfer Capacitance	C <sub>rss</sub>		f = 1 MHz		3	-	
Effective Output Capacitance, Energy Related <sup>a</sup>	C <sub>o(er)</sub>	V 0V 500VV 0V		-	233	-	pF
Effective Output Capacitance, Time Related <sup>b</sup>	C <sub>o(tr)</sub>	$V_{DS} = 0$	$V_{DS} = 0 \text{ V to } 520 \text{ V}, V_{GS} = 0 \text{ V}$		939	-	
Total Gate Charge	Qg		V <sub>GS</sub> = 10 V		247	371	nC
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V			65	-	
Gate-Drain Charge	Q <sub>gd</sub>			-	93	-	1
Turn-On Delay Time	t <sub>d(on)</sub>	V <sub>DD</sub> = 520 V, I <sub>D</sub> = 30.5 A,		-	59	89	- ns
Rise Time	t <sub>r</sub>			-	107	161	
Turn-Off Delay Time	t <sub>d(off)</sub>	V <sub>GS</sub> =	$V_{GS} = 10 \text{ V}, R_g = 9.1 \Omega$		217	326	
Fall Time	t <sub>f</sub>			-	133	200	1
Gate Input Resistance	$R_g$	f = 1 MHz, open drain		0.5	1	2	Ω
Drain-Source Body Diode Characteristics	S						
Continuous Source-Drain Diode Current	Is	MOSFET sym	MOSFET symbol showing the		-	64	_
Pulsed Diode Forward Current	I <sub>SM</sub>	integral reverse p - n junction diode		-	-	199	- A
Diode Forward Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 30.5 A, V <sub>GS</sub> = 0 V		-	0.9	1.2	V
Reverse Recovery Time	t <sub>rr</sub>		0 -2 -, 3, 143 - 1		212	474	ns
Reverse Recovery Charge	Q <sub>rr</sub>	$T_J = 25 ^{\circ}\text{C}$ , $I_F = I_S = 30.5 \text{A}$ , $dI/dt = 100 \text{A/}\mu\text{s}$ , $V_R = 400 \text{V}$		-	2.1	3.8	μC
Reverse Recovery Current	I <sub>RRM</sub>			_	18	-	Α

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ .

b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ .



## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

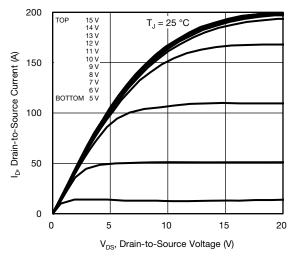


Fig. 1 - Typical Output Characteristics

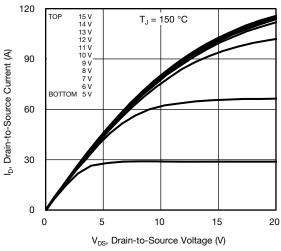


Fig. 2 - Typical Output Characteristics

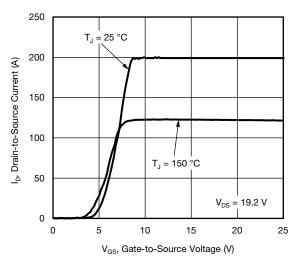


Fig. 3 - Typical Transfer Characteristics

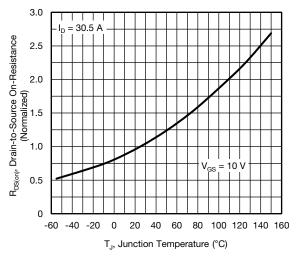


Fig. 4 - Normalized On-Resistance vs. Temperature

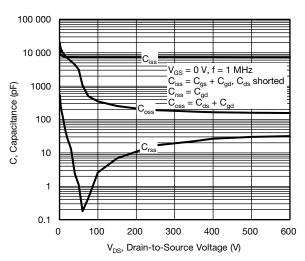


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

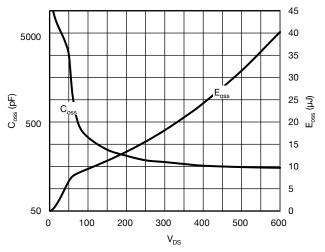


Fig. 6 - Coss and Eoss vs. VDS



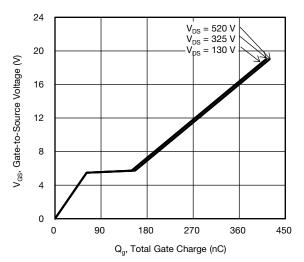


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

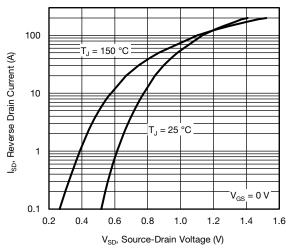


Fig. 8 - Typical Source-Drain Diode Forward Voltage

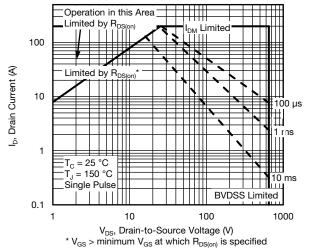


Fig. 9 - Maximum Safe Operating Area

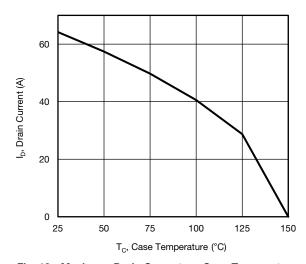


Fig. 10 - Maximum Drain Current vs. Case Temperature

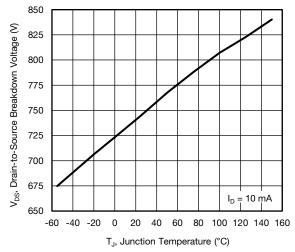


Fig. 11 - Temperature vs. Drain-to-Source Voltage



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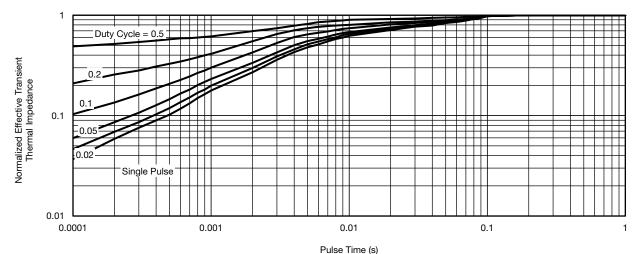


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

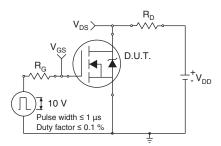


Fig. 13 - Switching Time Test Circuit

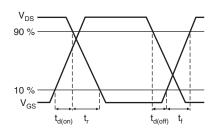


Fig. 14 - Switching Time Waveforms

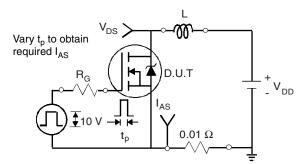


Fig. 15 - Unclamped Inductive Test Circuit

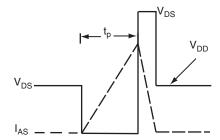


Fig. 16 - Unclamped Inductive Waveforms

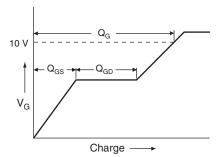


Fig. 17 - Basic Gate Charge Waveform

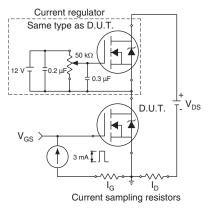
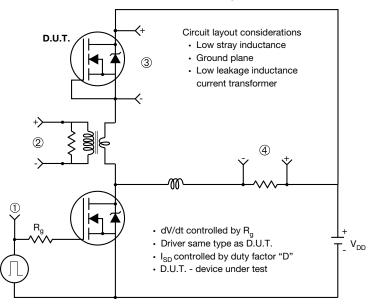


Fig. 18 - Gate Charge Test Circuit



### Peak Diode Recovery dV/dt Test Circuit



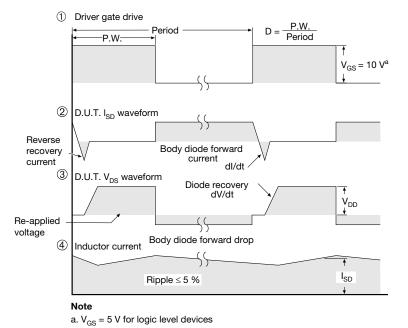
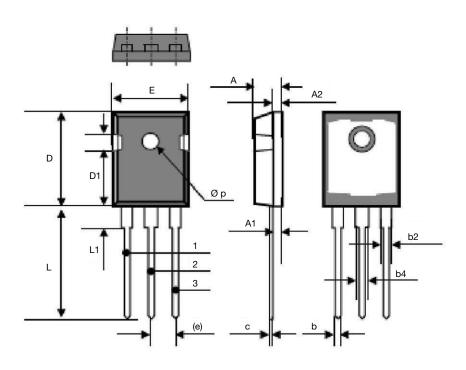


Fig. 19 - For N-Channel

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# **TO-247AD (High Voltage)**



DIM.	MILLIN	METERS	INCHES		
	MIN.	MAX.	MIN.	MAX.	
Α	4.70	5.31	0.185	0.209	
A1	2.21	2.59	0.087	0.102	
A2	1.50	2.49	0.059	0.098	
b	0.99	1.40	0.039	0.055	
b2	1.65	2.41	0.065	0.095	
b4	2.59	3.43	0.102	0.135	
С	0.61 BSC		0.024 BSC		
D	20.80	21.46	0.819	0.845	
D1	3.68	5.49	0.145	0.216	
(e)	5.46 BSC		0.215 BSC		
E	15.49	16.26	0.610	0.640	
L	19.81	20.32	0.780	0.800	
L1	4.06	4.50	0.160	0.177	
Øp	3.51	3.66	0.138	0.144	
ECN: S17-0178-Rev. B. 0	6-Feb-17	•	<u> </u>		

ECN: S17-U178-Rev. B, U6-Feb-17

DWG: 6010



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